# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

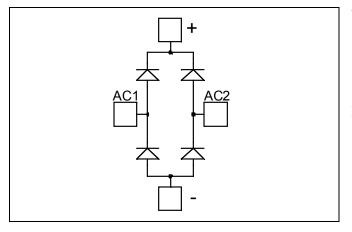
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





## APTDF100H120G

## Diode Full Bridge Power Module



### $V_{RRM} = 1200V$ $I_{C} = 100A$ @ Tc = 60°C

#### Application

- Uninterruptible Power Supply (UPS)
- Induction heating
- Welding equipment
- High speed rectifiers

#### Features

- Ultra fast recovery times
- Soft recovery characteristics
- High blocking voltage
- High current
- Low leakage current
- Very low stray inductance
  - Symmetrical design
  - Lead frames for power connections
- High level of integration

#### Benefits

- Outstanding performance at high frequency operation
- Low losses
- Low noise switching
- Solderable terminals for easy PCB mounting
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- RoHS Compliant

#### Absolute maximum ratings

Symbol	Parameter			Max ratings	Unit			
V <sub>R</sub>	Maximum DC reverse Voltage			1200	V			
V <sub>RRM</sub>	Maximum Peak Repetitive Reverse Voltage				1200	v		
т	Maximum Average Forward	1 Duty avala = 500/		$T_C = 25^{\circ}C$	120	Δ		
$I_{F(AV)}$	Current			$T_C = 60^{\circ}C$	100			
I <sub>F(RMS)</sub>	RMS Forward Current	Duty cycle = $50\%$		$T_C = 45^{\circ}C$	135	11		
I <sub>FSM</sub>	Non-Repetitive Forward Surge Cu	rrent	8.3 ms	$T_C = 45^{\circ}C$	500			

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handing Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

#### www.microsemi.com

### 



#### All ratings (a) $T_j = 25^{\circ}C$ unless otherwise specified

#### **Electrical Characteristics**

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit	
	Diode Forward Voltage	$I_{\rm F} = 100{\rm A}$			2.4	3	
V <sub>F</sub>		$I_{\rm F} = 150 {\rm A}$			2.7		V
		$I_{\rm F} = 100  {\rm A}$	$T_{j} = 125^{\circ}C$		1.8		
т	Maximum Reverse Leakage Current	$V_{R} = 1200 V$	$T_j = 25^{\circ}C$			100	۸
I <sub>RM</sub>	Maximum Reverse Leakage Current	$T_{j} = 125^{\circ}C_{j}$	$T_j = 125^{\circ}C$			500	μA
C <sub>T</sub>	Junction Capacitance	$V_{\rm R} = 1200  {\rm V}$			110		pF

### **Dynamic Characteristics**

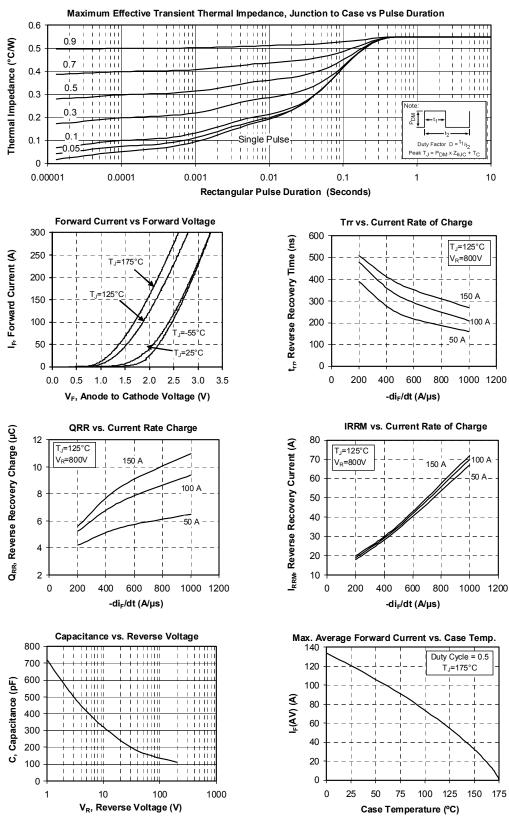
Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
t <sub>rr</sub>	Reverse Recovery Time	$I_F=1A, V_R=30V$ $di/dt = 100A/\mu s$	$T_j = 25^{\circ}C$		45		ns
t <sub>rr</sub>	Reverse Recovery Time		$T_j = 25^{\circ}C$		385		ns
٩r	Reverse Receivery Time		$T_{j} = 125^{\circ}C$		480		115
Q <sub>rr</sub>	Reverse Recovery Charge	$I_{\rm F} = 100 {\rm A}$ $V_{\rm R} = 800 {\rm V}$	$T_j = 25^{\circ}C$		1055		nC
ЧП	Reverse Receivery charge	$di/dt = 200 A/\mu s$	$T_{j} = 125^{\circ}C$		5240		
I <sub>RRM</sub>	Reverse Recovery Current	erse Recovery Current	$T_j = 25^{\circ}C$		6		А
*KKM	Teverse Recovery Current		$T_{j} = 125^{\circ}C$		19		
t <sub>rr</sub>	Reverse Recovery Time	$I_{\rm F} = 100 {\rm A}$ $V_{\rm R} = 800 {\rm V}$ $di/dt = 1000 {\rm A}/\mu {\rm s}$			210		ns
Qπ	Reverse Recovery Charge		$T_{j} = 125^{\circ}C$		9.4		μC
I <sub>RRM</sub>	Reverse Recovery Current				70		Α

#### Thermal and package characteristics

Symbol	Characteristic			Min	Тур	Max	Unit
R <sub>thJC</sub>	Junction to Case Thermal Resistance					0.55	°C/W
V <sub>ISOL</sub>	RMS Isolation Voltage, any terminal to case t =1 min, I isol<1mA, 50/60Hz			2500			V
T <sub>J</sub>	Operating junction temperature range			-40		175	°C/W V °C N.m
T <sub>STG</sub>	Storage Temperature Range			-40		125	
T <sub>C</sub>	Operating Case Temperature			-40		100	
Torque	Mounting torque	To Heatsink	M5	2.5		4.7	N.m
Wt	Package Weight					160	g



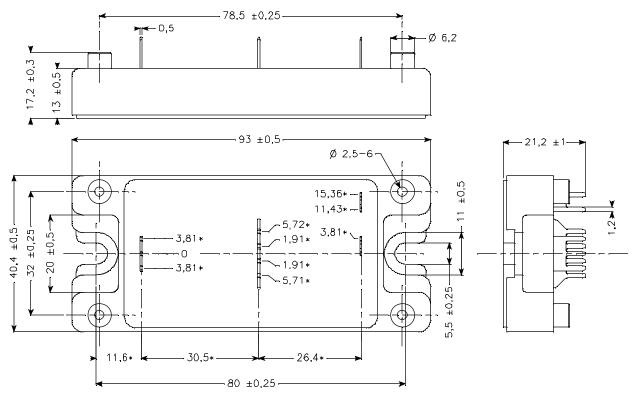
#### **Typical Performance Curve**



APTDF100H120G - Rev 1 June, 2006



#### SP4 Package outline (dimensions in mm)



ALL DIMENSIONS MARKED " \* " ARE TOLERENCED AS :  $\oint \emptyset 1$ 

Microsemi reserves the right to change, without notice, the specifications and information contained herein

Microsemi's products are covered by one or more of U.S patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents. U.S and Foreign patents pending. All Rights Reserved.